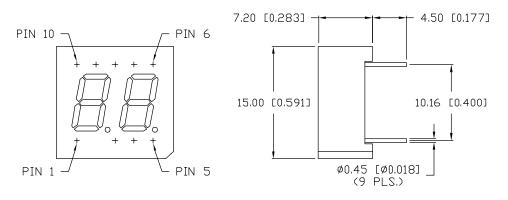
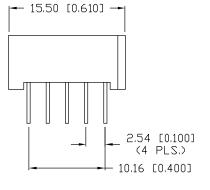
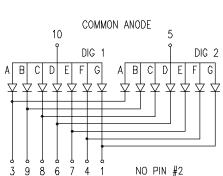
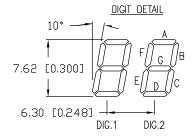
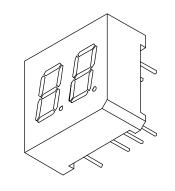
LDD-E302NI-UPG











ELECTRO-OPTICAL C	HARACTERIST	TCS TA=25	·C	$I_f = 10mA$	
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		525		nm	_
FORWARD VOLTAGE		3.5	4.0	Vf	
REVERSE VOLTAGE	5.0			V_r	I _r =100μΑ
AXIAL INTENSITY		7000		μcd	$I_f = 10 \text{mA}$
EMITTED COLOR:	GREEN				
FACE COLOR:	GRAY				
SEGMENT COLOR:	MILKY WE	HITE DIFFUS	ED		

LIMITS OF SAFE OPERATION AT 25°C PER CHIPS

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	120	mW
DERATE FROM 25°C	-1.6	mW/°C
OPERATING, STORAGE TEMP.	-40 TD +85	°C
SOLDERING TEMP.	+ 260	°C
2.0mm FROM BODY		3 SEC. MAX

* t<10µS

CAUTION: STATIC SENSITIVE DEVICE
FOLLOW PROPER E.S.D. HANDLING PROCEDURES
WHEN WORKING WITH THIS PART.

UNCONTROLLED DOCUMENT

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION -0.00

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



290 E. HELEN ROAD PALATINE, IL 60067-6976 PHONE: +1.847.359.2790 US WEB: www.lumex.com TW WEB: www.lumex.com.tw

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APPROVED BY: DATE:

PAGE: 1 OF 1 SCALE: N/A

6.21.03

REV.

PART NUMBER
LDD-E302NI-UPG

0.30" SEVEN SEGMENT, DUAL DIGIT, LED DISPLAY, 525nm GREEN CHIPS, GRAY FACE WITH WHITE SEGMENTS, MULTIPLEXED, COMMON ANODE.